

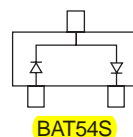
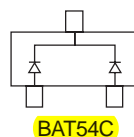
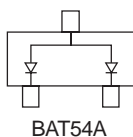
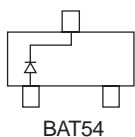
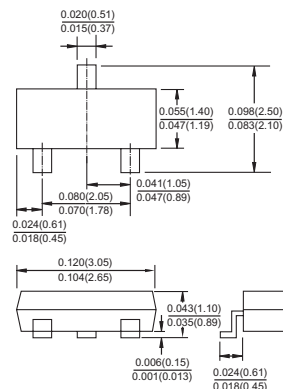
Features

- ✧ Low turn-on voltage
- ✧ Fast switching
- ✧ PN junction guard ring for transient and ESD protection

Mechanical Data

- ✧ Case: SOT-23, Molded plastic
- ✧ Terminals: Solderable per MIL-STD-202, Method 208

SOT-23



Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise specified

Type Number	Symbol	Value	Units
Peak Repetitive Reverse Voltage	V_{RRM}	30	V
Working Peak Reverse Voltage	V_{RWM}		
DC Blocking Voltage	V_R		
Forward Continuous Current	I_F	200	mA
Repetitive Peak Forward Current	I_{FM}	300	mA
Forward Surge Current @ $t=1.0\text{s}$	I_{FSM}	600	mA
Power Dissipation (Note 1)	P_d	200	mW
Thermal Resistance Junction to Ambient Air	$R_{\theta JA}$	500	$^\circ\text{C/W}$
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to +125	$^\circ\text{C}$

Electrical Characteristics

Type Number	Symbol	Min	Typ	Max	Units
Reverse Breakdown Voltage (Note 1)	$V_{(BR)R}$	30	-	-	V
Reverse Leakage Current (Note 1) $V_R=25\text{V}$	I_R	-	-	2.0	μA
Forward Voltage (Note 1) $I_F=0.1\text{mA}$ $I_F=1.0\text{mA}$ $I_F=10\text{mA}$ $I_F=30\text{mA}$ $I_F=100\text{mA}$	V_F	-	-	240 320 400 500 1000	mV
Junction Capacitance $V_R=0, f=1.0\text{MHz}$	C_j	-	-	10	pF
Reverse Recovery Time (Note 2)	t_{rr}	-	-	5.0	nS

Notes: 1. Short Duration Pulse Test used to Minimize Self-Heating Effect.

2. Reverse Recovery Test Conditions: $I_F=10\text{mA}$ through $I_R=10\text{mA}$ to $I_R=1.0\text{mA}$,
 $R_L=100\Omega$.

FIG.1- POWER DERATING CURVE

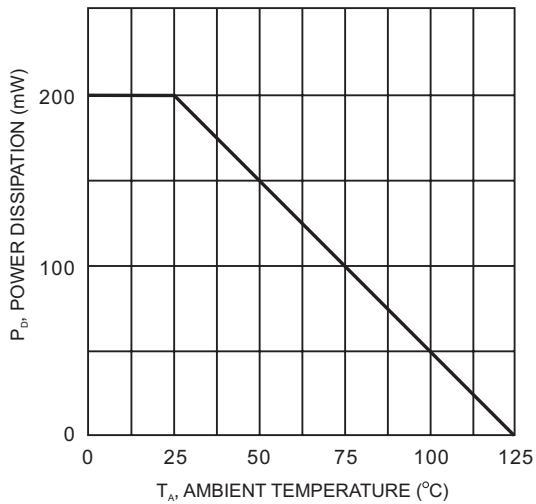


FIG.2- TYPICAL FORWARD CHARACTERISTICS

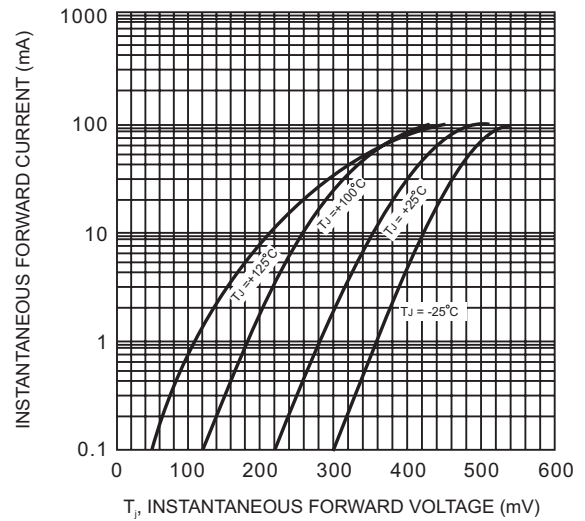


FIG.3- TYPICAL REVERSE CHARACTERISTICS

